Silicon N-Channel MOS FET

HITACHI

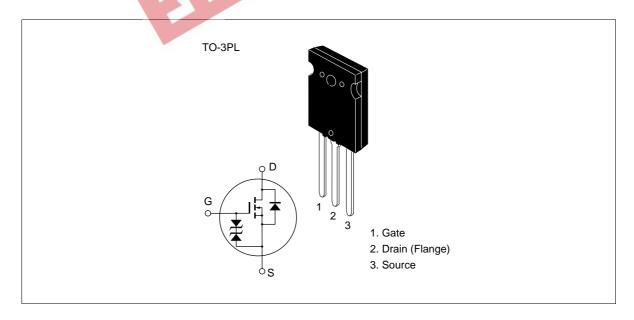
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- · com.cn Suitable for switchingregulator, DC-DC converter

Outline





Absolute Maximum Ratings (Ta = 25°C)

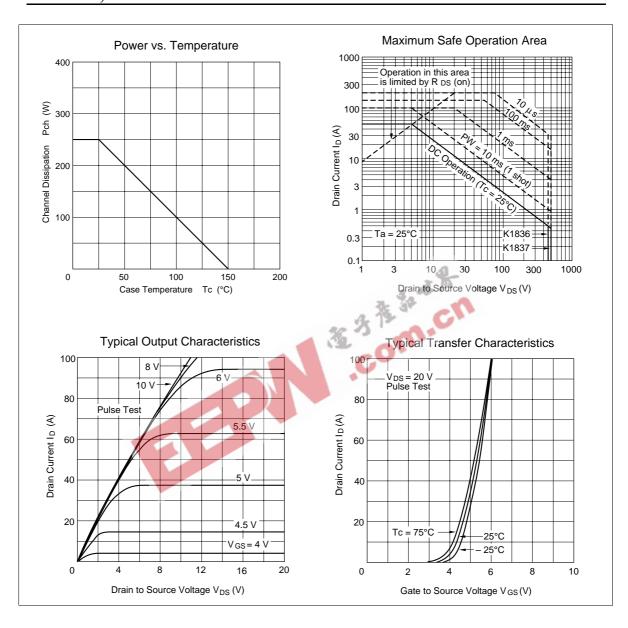
Item		Symbol	Ratings	Unit				
Drain to source voltage	K1836	$V_{\scriptscriptstyle DSS}$	450	V				
	K1837		500					
Gate to source voltage		V_{GSS}	±30	V				
Drain current		I _D	50	А				
Drain peak current		I _{D(pulse)} *1	200	А				
Body to drain diode reverse drain cu	I _{DR}	50	А					
Channel dissipation	Pch*2	250	W					
Channel temperature		Tch	150	°C				
Storage temperature		Tstg	-55 to +150	°C				
Storage temperature Tstg −55 to +150 °C Notes 1. PW ≤ 10 μs, duty cycle ≤ 1 % 2. Value at Tc = 25 °C								

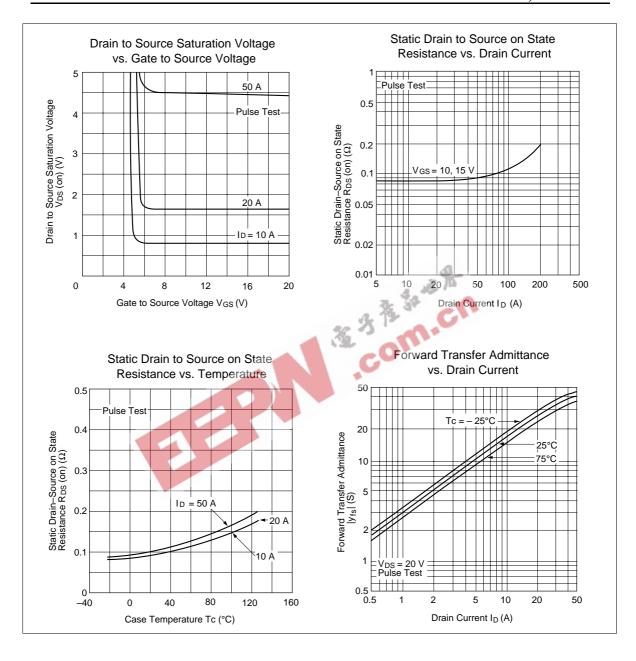


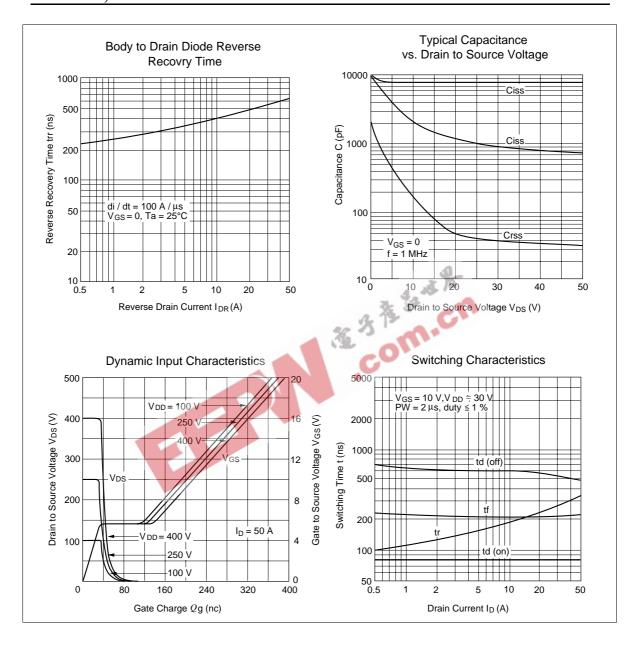
Electrical Characteristics ($Ta = 25^{\circ}C$)

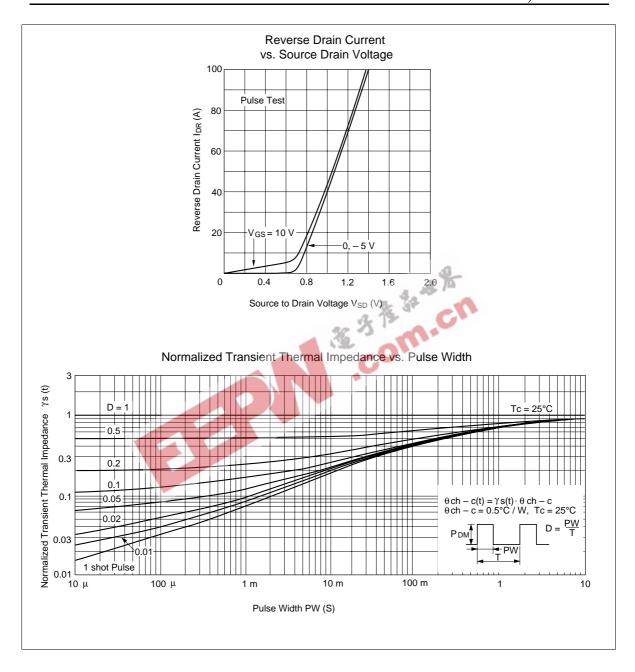
Item		Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source	K1836	$V_{(BR)DSS}$	450	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
breakdown voltage	K1837		500	_	_		
Gate to source b voltage	reakdown	$V_{(BR)GSS}$	±30	_	_	V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current		$I_{\rm GSS}$	_		±10	μΑ	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$
Zero gate	K1836	I _{DSS}	_	_	250	μΑ	$V_{DS} = 360 \text{ V}, V_{GS} = 0$
voltage drain current	K1837						$V_{DS} = 400 \text{ V}, V_{GS} = 0$
Gate to source c	utoff voltage	$V_{GS(off)}$	2.0	_	3.0	V	$I_{D} = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to	K1836	$R_{\scriptscriptstyle DS(on)}$	_	0.08	0.10	Ω	$I_{\rm D} = 25 \text{ A}$
source on state resistance	K1837		_	0.085	0.11	30	V _{GS} = 10 V*1
Forward transfer	admittance	y _{fs}	22	35	-0	S	I _D = 25 A V _{DS} = 10 V* ¹
Input capacitance	е	Ciss	4 '	8150	1	pF	V _{DS} = 10 V
Output capacitan	ice	Coss	-), /	2100	_	pF	$V_{GS} = 0$
Reverse transfer	capacitance	Crss		180	_	pF	f = 1 MHz
Turn-on delay tin	ne	t _{d(on)}	_	80	_	ns	I _D = 25 A
Rise time		t,	_	250	_	ns	$V_{GS} = 10 \text{ V}$
Turn-off delay tin	ne	t _{d(off)}	_	550	_	ns	$R_L = 1.2 \Omega$
Fall time		t _f	_	220	_	ns	
Body to drain dio voltage	de forward	V_{DF}	_	1.1	_	V	$I_F = 50 \text{ A}, V_{GS} = 0$
Body to drain dio recovery time	de reverse	t _{rr}	_	620	_	ns	$I_F = 50 \text{ A}, V_{GS} = 0,$ $di_F / dt = 100 \text{ A} / \mu \text{s}$

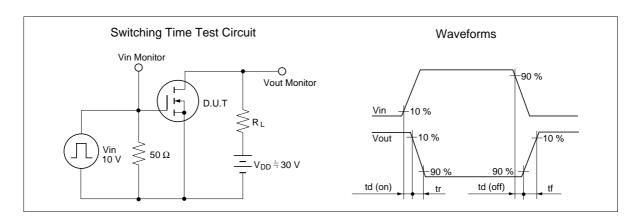
Note 1. Pulse Test











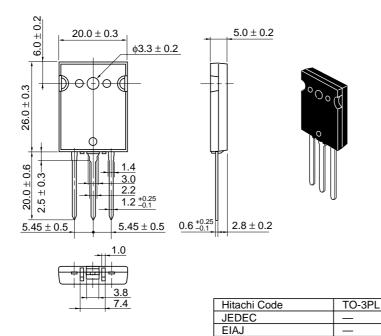




Unit: mm

9.9 g

Weight (reference value)



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